

JOURNAL OF ALLOYS AND COMPOUNDS

(Formerly Journal of the Less-Common Metals)

Editor-in-Chief

Professor K. H. J. Buschow
Van der Waals-Zeeman Laboratorium
Universiteit van Amsterdam
Valckenierstraat 65
1018 XE Amsterdam, Netherlands
Fax: +31 (20) 525 5788
e-mail: buschow@science.uva.nl

Editors

Professor H. Kleinke
Dept. of Chemistry
University of Waterloo
Waterloo, Ontario N2L 3G1
Canada
Tel.: +1 (519) 885 1211
Fax: +1 (519) 746 0435
e-mail: jalcom@uwaterloo.ca

Professor H.G. Pan
Department of Materials Science and
Engineering
Zhejiang University
Hangzhou 310029
P.R. China
Tel. & Fax: +86 (571) 87952615
e-mail: Honggepan@zju.edu.cn

Professor H. Sakaguchi
Department of Materials Science
Tottori University
Minami 4-101, Koyama-cho
Tottori 680-0945
Japan
Tel. & Fax: +81 (857) 31 5265
e-mail: sakaguch@chem.tottori-u.ac.jp

Professor L. Schultz
Leibniz -Institut fuer Festkoerper- und
Werkstofforschung (IFW) Dresden
Helmholtzstrasse
20D-01069 Dresden, Germany
Tel: +49-351-4659-100
Fax: +49-351-4659-500
e-mail: l.schultz@ifw-dresden.de

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Publication information: *Journal of Alloys and Compounds* (ISSN 0925-8388). For 2011, volume 509 is scheduled for publication by Elsevier (Radarweg 29, 1043 NX Amsterdam, the Netherlands). Further information on this journal is available from the Publisher or from the Elsevier Customer Service Department nearest you or from this journal's website (<http://www.elsevier.com/locate/jallcom>). Information on other Elsevier products is available through Elsevier's website (<http://www.elsevier.com>). Periodicals Postage Paid at Rahway, NJ, and at additional mailing offices.

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USA mailing notice: *Journal of Alloys and Compounds* (ISSN 0925-8388) is published semimonthly by Elsevier B.V. (Radarweg 29, 1043 NX Amsterdam, The Netherlands). Periodical postage paid at Rahway NJ and additional mailing offices.

USA POSTMASTER: Send change of address to *Journal of Alloys and Compounds*, Elsevier Customer Service Department, 3251 Riverport Lane, Maryland Heights, MO 63043, USA.

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